# PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3035663

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
ATSUSHI MATSUMOTO	09/11/2014
TAKAHIRO OHKOSHI	09/11/2014
HIDEKI KATSURA	09/11/2014
MORIYUKI WATANUKI	09/13/2014

### **RECEIVING PARTY DATA**

Name:	TERUMO KABUSHIKI KAISHA
Street Address:	44-1, HATAGAYA 2-CHOME
Internal Address:	SHIBUYA-KU
City:	TOKYO
State/Country:	JAPAN

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14485148

## **CORRESPONDENCE DATA**

Fax Number: (303)863-0223

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 3038639700

Email: kjohnston@sheridanross.com

**Correspondent Name:** SHERIDAN ROSS P.C. Address Line 1: 1560 BROADWAY

Address Line 2: **SUITE 1200** 

Address Line 4: DENVER, COLORADO 80202

ATTORNEY DOCKET NUMBER:	7994-1
NAME OF SUBMITTER:	TADD F. WILSON
SIGNATURE:	/Tadd F. Wilson/
DATE SIGNED:	09/24/2014

# **Total Attachments: 4**

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> **PATENT REEL: 033804 FRAME: 0680** 502989064

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PATENT REEL: 033804 FRAME: 0681

## **Worldwide Assignment**

V	/HERE/	AS, I/W	′e <u>A</u>	<u>ktsushi N</u>	<u>latsumo</u>	to, Takah	<u>iro</u>	<u>Ohkoshi,</u>	<u>Hideki</u>	Katsura	, and	10M	<u>riyuki</u>
<u>Watanuk</u> i	j, have	made	an	invention	entitled	"SENSOF	R IN	SERTION	DEVIC	E AND	METH	IOD	FOR
<u>OPERATI</u>	NG SA	ID DE	/ICE	<u>≡</u> " for wh	ich I/We	have filed	an	application	for Let	ters Pate	nt of t	he L	Jnited
States on		, ur	nder	Applicati	on No		a	ınd					

WHEREAS, <u>TERUMO KABUSHIKI KAISHA</u> ("ASSIGNEE"), a corporation or other business entity duly registered in the State/Country of <u>Japan</u>, whose postal address is <u>44-1</u>, <u>Hatagaya 2-chome</u>, <u>Shibuya-ku</u>, <u>Tokyo</u>, <u>Japan</u>, desires to acquire the entire right, title, and interest in and to the invention, the application, and any Letters Patent to be granted for the invention in the United States and in all foreign countries:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which I/We acknowledge, I/We, have sold, assigned, transferred, and conveyed, and do hereby sell, assign, transfer, and convey unto ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest in and to the invention, the application, all applications claiming benefit of the application, including, but not limited to, all divisions and continuations of the application, and all Letters Patent that may be granted thereon in the United States, Canada and in all foreign countries, and all reissues thereof, together with the right to claim priority under the International Convention in all member countries; and I/We authorize and request the Director of Patents and Trademarks to issue all Letters Patent for the invention to ASSIGNEE, its successors, legal representatives, and assigns in accordance with the terms of this Assignment;

AND I/We covenant and agree that I/We have the full right to convey the entire right, title, and interest herein assigned and that I/We have not executed and will not execute any assignment or other instrument in conflict with this Assignment;

AND I/We further covenant and agree that upon request by ASSIGNEE, its successors, legal representatives, and/or assigns, and without further consideration, I/We will do all lawful acts that may be necessary or desirable to assist ASSIGNEE, its successors, legal representatives, and/or assigns to obtain and enforce patent protection for the invention in the United States and in all foreign countries, including, but not limited to, communicate with ASSIGNEE, its successors, legal representatives, and/or assigns any facts known to me/us regarding the invention, testify in any legal proceeding, sign all lawful papers, execute and deliver all papers that may be necessary or desirable to perfect the title to the invention in ASSIGNEE, its successors, legal representatives, and/or assigns, execute all divisional, continuation, and reissue applications, and make all rightful oaths, it being understood that any expense incident to the rendering of such assistance will be borne by ASSIGNEE, its successors, legal representatives, and/or assigns;

PATENT REEL: 033804 FRAME: 0682

AND I/We further hereby authorize ASSIGNEE, or its attorneys or agents, to insert the correct Application Number and filing Date into this Assignment, if none is indicated on that date of my/our execution of this agreement.

IN WITNESS WHEREOF, I/We have executed this Assignment on the date(s) indicated below.

Signature: Date: Full Name: Address:	Atsushi Matsumoto  2014. 9. 11  Atsushi Matsumoto  c/o Terumo Kabushiki Kaisha  1500 Inokuchi, Nakai-machi  Ashigarakami-gun  Kanagawa 259-0150  JAPAN	Signature: Date: Full Name: Address:	Takahiro Ohkoshi 2014. 9. 11  Takahiro Ohkoshi c/o Terumo Kabushiki Kaisha 1500 Inokuchi, Nakai-machi Ashigarakami-gun Kanagawa 259-0150  JAPAN
Signature: Date:		Signature:	
Full Name:	Hideki Katsura	Full Name:	Moriyuki Watanuki
Address:	c/o Terumo Kabushiki Kaisha	Address:	9-14, Kamagaya 4-chome,
	3-20-2, Nishi-shinjuku, Shinjuku-ku,		Kamagaya-shi
	Tokyo 163-1450		Chiba 273-0106
	JAPAN		JAPAN

AND I/We further hereby authorize ASSIGNEE, or its attorneys or agents, to insert the correct Application Number and filing Date into this Assignment, if none is indicated on that date of my/our execution of this agreement.

IN WITNESS WHEREOF, I/We have executed this Assignment on the date(s) indicated below.

Signature:		Signature:	····
Date:		Date:	****
Full Name:	Atsushi Matsumoto	Full Name:	Takahiro Ohkoshi
Address:	c/o Terumo Kabushiki Kaisha	Address:	c/o Terumo Kabushiki Kaisha
	1500 Inokuchi, Nakai-machi		1500 Inokuchi, Nakai-machi
	Ashigarakami-gun		Ashigarakami-gun
	Kanagawa 259-0150		Kanagawa 259-0150
	JAPAN		JAPAN
Signature:	Hideki Katowra 9 / 11 / 2014	Signature:	
Date:	9/11/2014	Date:	
Full Name:	Hideki Katsura	Full Name:	Moriyuki Watanuki
Address:	c/o Terumo Kabushiki Kaisha	Address:	9-14, Kamagaya 4-chome,
	3-20-2, Nishi-shinjuku, Shinjuku-ku,		Kamagaya-shi
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Signature:		Signature:	
Date:		Date:	
Full Name:	Atsushi Matsumoto	Full Name:	Takahiro Ohkoshi
Address:	c/o Terumo Kabushiki Kaisha	Address:	c/o Terumo Kabushiki Kaisha
	1500 Inokuchi, Nakai-machi		1500 Inokuchi, Nakai-machi
	Ashigarakami-gun		Ashigarakami-gun
	Kanagawa 259-0150		Kanagawa 259-0150
	JAPAN		JAPAN
Signature:		Signature:	MOHYUKI WATANUKI
Date:	Police	Date:	13/9/2014
Full Name:	Hideki Katsura	Full Name:	Moriyuki Watanuki
Address:	c/o Terumo Kabushiki Kaisha	Address:	9-14, Kamagaya 4-chome,
	3-20-2, Nishi-shinjuku, Shinjuku-ku,		Kamagaya-shi
	Tokyo 163-1450		Chiba 273-0106
	JAPAN		JAPAN